PCN	Number:	201506240	00				PCN Da	ite:	07/07/2015	
Title	: Datasheet up	date for LP88	860)-Q1						
		PCN Manager					ept:	Quality Services		
Chai	nge Type:									
	Assembly Site				p Site					
	ssembly Process		\boxtimes				Wafer Bump Mat		p Material	
	Assembly Materia			Part number change			Wafer	fer Bump Process		
	Mechanical Specification		Test Site			Wafer				
ш	Packing/Shipping/Labeling			Test Process				er Fab Materials		
	Wafer Fab Process									
PCN Details Description of Change:										
	s Instruments Inc		ann/	ouncing an	information onl	v n	otificatio	\n		
LP88	product datasheet 8 60-Q1 1218-MAY 2014-REVISED M.		d as	s seen in th	e change revisio	on r	nistory b	<i>i</i> a Te	XAS STRUMENTS www.ti.com	
Chan	ges from Revision A (J	une 2014) to Rev	isior	n B					Page	
	-	•								
	Added storage temperature to Ab Max Ratings table from Handling Ratings table; replace Handling Ratings with ESD Ratings									
• Ch	Deleted word "SYMBOL" from header row of EC tables									
• Ad	Added sentence at end of PWM-Input Direct Control subsection							20		
• Ch	Changed EXT_TEMP_MINUS[1:0] from "2, 6, 10, 14 μA" to "1, 5, 9, 13 μA"							38		
• Ad	Added EEPROM values for LP8860D and LP8860E in "Default EEPROM Context" table							47		
• Ch	Changed 0xFF to 0x88 for EEPROM REG 23 Address, "A" option									
· Ch										
• Ad	Added standard Application Note to beginning of Application and Implementation section								82	
• Ad	Added Documentation Support section								100	
	datasheet number	will be chang	ging				1			
	Device Family			Change From:					ge To:	
LP8	LP8860-Q1			SNVSA21A				SNVSA21B		
http:	e changes may be //www.ti.com/pro son for Change:			datasheet	links provided.					
	nore accurately ref	lect device ch	nara	acteristics.						
	•				uality or Relial	oilit	ty (posi	tive	/ negative):	
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.										
Chai	nges to product	<u>identificatio</u>	n r	esulting fi	rom this PCN:					
None										
Proc	luct Affected:									
	860AQVFPRQ1	LP8860BQ	VFF	PRQ1	LP8860DQVFPR	Q1	LP	8860	QVFPRQ1	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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